



CCD VERTICAL DRIVER FOR DIGITAL CAMERAS

FEATURES

- CCD Vertical Driver:
 - Three Field CCD Support
 - Two Field CCD Support
- Output Drivers:
 - 3 Levels Driver (V-Transfer) x 5
 - 2 Levels Driver (V-Transfer) x 3
 - 2 Levels Driver (E-Shutter) x 1
- Drive Capability:
 - 450 pF to 1890 pF With 60 Ω to 240 Ω
- Input Phase:
 - 3 State (V-Transfer) x 5
 - 2 State (V-Transfer) x 3
 - 2 State (E-Shutter) x 1
- Portable Operation:
 - Input Interface: 2.7 V to 5.5 V

Power Supply:

- VDD 2.7 V to 5.5 V - VL -5 V to -9 V

– VM GND

APPLICATIONS

- VH

- Digital Camera
- Video Camera

DESCRIPTION

The VSP1900 is a CCD vertical clock driver with electricshutter support. This device is composed of eight vertical transfer channels, which support both 3-field CCD and 2-field CCD operation. The VSP1900 contributes low power consumption and parts number reduction in the system.

11.5V to 15.5 V



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

SLES062 - MARCH 2003



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ORDERING INFORMATION

PRODUCT	PACKAGE	PACKAGE DESIGNATOR	OPERATING TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER	TRANSPORT MEDIA
V0D4000	TCCODO	DDT	0500 to 0500	V0D4000	V0D4000	Tube (60 units/tube)
VSP1900	TSSOP30	DBT	−25°C to 85°C	VSP1900	VSP1900	Tape and reel

⁽¹⁾ For the most current specification and package information, refer to our web site at www.ti.com.

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted(1)

		UNITS
	VDD	GND -0.3 V to 7 V
Supply voltage	VL	GND to -10 V
	VH	VL + 26 V
Input voltage, V _{IN}		GND -0.3 V to (VDD + 0.3 V)
Ambient temperature under bias		−25°C to 85°C
Storage temperature, T _{Stg}		−55°C to 150°C
Junctiontemperature		150°C
Package temperat	235°C	

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

free-air temperature range unless otherwise noted

	MIN	NOM	MAX	UNIT
Supply voltage, VDD	2.7		5.5	V
Supply voltage, VL	-5		-9	V
Supply voltage, VH	11.5		15.5	V
		GND - 0.3		
Input voltage, VIN	1	to (VDD + 0.3)		V

TRUTH TABLE

	INI	PUT			OUTPUT	
V1N V3AN V3BN V5AN V5BN	CH1N CH2N CH3N CH4N CH5N	V2N V4N V6N	SUBN	V1 V3A V3B V5A V5B	V2 V4 V6	SUB
L	L	Х	Х	VH	Х	Х
L	Н	Х	Х	VM	Х	Х
Н	L	Х	Х	Z	Х	Х
Н	Н	Х	Х	VL	Х	Х
Χ	Х	L	Х	Х	VM	Х
Χ	Х	Н	Х	Х	VL	Х
Χ	Х	Х	L	Х	Х	VH
Х	Х	Х	Н	Х	Х	VL

NOTE: Z = High impedance

X = Don't care



ELECTRICAL CHARACTERISTICS

all specifications at $T_A = 25$ °C (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
	DC power consumption			5.3		mW
	Switching power consumption	VSP2267 (TG) with loading diagram		550		mW
DC CHA	ARACTERISTICS					
VIН	High-level input voltage		0.7VDD			V
VIL	Low-level input voltage				0.2VDD	V
IIN	Input current	V _{IN} = GND to 5 V (without pullup / pulldown resistor)	-10	0	10	
		V _{IN} = GND to 5 V (pullup / pulldown resistor)	-625	0	625	μΑ
lΗ				0.1	0.2	
I _{DD}	Operating supply current			1		mA
ΙL				0.125		
loL		V1, V2, V3A, V3B, V4, V5A, V5B, V6 = -8.1 V	10			
I _{OM1}		V1, V2, V3A, V3B, V4, V5A, V5B, V6 = -0.2 V			- 5	
I _{OM2}	Outroot command	V1, V3A, V3B, V5A, V5B = 0.2 V	5			
ІОН	Output current	V1, V3A, V3B, V5A, V5B = 14.55 V			-7.2	mA
losL		SUB = -8.1 V	5.4			
IOSH		SUB = 14.55 V		•	-4	

SWITCHING CHARACTERISTICS

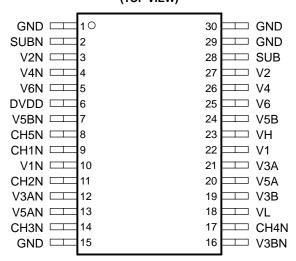
all specifications at $T_A = 25$ °C (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t _d (PLM)				15	100	
t _d (PMH)				20	100	
td(PLH)	Dropogotion doloy-time			20	100	
td(PML)	Propagation delay time			15	50	ns
td(PHM)				30	50	
td(PHL)				30	50	
tr(TLM)		$VL \to VM$			300	
tr(TMH)	Rise time	$VM \rightarrow VH$			300	ns
tr(TLH)		$VL \to VH$			300	
t _f (TML)		$VM \to VL$			300	ns
t _f (THM)	Fall time	$VH \to VM$			300	
t _f (THL)		$VH \to VL$			300	
V _{n(CLH)}						
V _{n(CLL)}						
V _n (CMH)	Output noise voltage				2	V
V _n (CML)						
V _{n(CHL)}						



PIN ASSIGNMENTS

DBT PACKAGE (TOP VIEW)

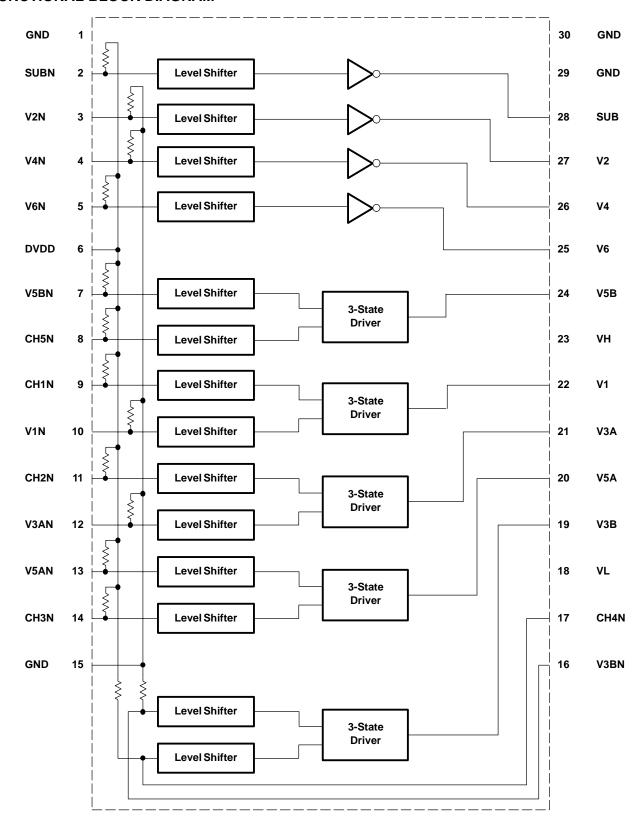


Terminal Functions

TERMINAL					
NAME	NO.	TYPE	DESCRIPTIONS		
GND	1	Р	Ground		
SUBN	2	DI	CCD substrate clock SUB input		
V2N	3	DI	Vertical transfer clock 2 input		
V4N	4	DI	Vertical transfer clock 4 input		
V6N	5	DI	Vertical transfer clock 6 input		
DVDD	6	Р	Digital power supply		
V5BN	7	DI	Vertical transfer clock 5B input		
CH5N	8	DI	Read out clock 5 input		
CH1N	9	DI	Read out clock 1 input		
V1N	10	DI	Vertical transfer clock 1 input		
CH2N	11	DI	Read out clock 2 input		
V3AN	12	DI	Vertical transfer clock 3A input		
V5AN	13	DI	Vertical transfer clock 5A input		
CH3N	14	DI	Read out clock 3 input		
GND	15	Р	Ground		
V3BN	16	DI	Vertical transfer clock 3B input		
CH4N	17	DI	Read out clock 4 input		
VL	18	Р	Digital power supply		
V3B	19	DO	Vertical transfer clock 3B output		
V5A	20	DO	Vertical transfer clock 5A output		
V3A	21	DO	Vertical transfer clock 3A output		
V1	22	DO	Vertical transfer clock 1 output		
VH	23	Р	Digital power supply		
V5B	24	DO	Vertical transfer clock 5B output		
V6	25	DO	Vertical transfer clock 6 output		
V4	26	DO	Vertical transfer clock 4 output		
V2	27	DO	Vertical transfer clock 2 output		
SUB	28	DO	CCD substrate clock SUB output		
GND	29	Р	Ground		
GND	30	Р	Ground		

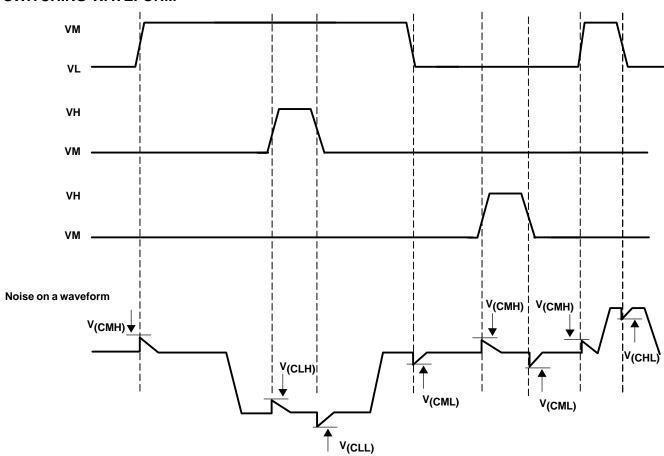


FUNCTIONAL BLOCK DIAGRAM





SWITCHING WAVEFORM





LOADING DIAGRAM

	R1, R2, R4, R6	60 Ω
Vertical clock series resistor	R3A, R5A	240 Ω
	R3B, R5B	Ω 08
	СФV1	1280 pF
West'red deed to OND	СФV3А, СФV3В	640 pF
Vertical clock to GND	СФV5А, СФV5В	640 pF
	CΦV2, CΦV4, CΦV6	400 pF
	СФV12	510 pF
	СФV23A, СФV23B	50 pF
Deturn a control de de	СФV45А, СФV45В	50 pF
Between vertical clock	СФV3A4, СФV3B4	260 pF
	СФV5A6, СФV5B6	260 pF
	СФV61	100 pF
Substrate clock to GND	СФVSUB	1000 pF
Vertical clock GND resistor	R GND	18 Ω

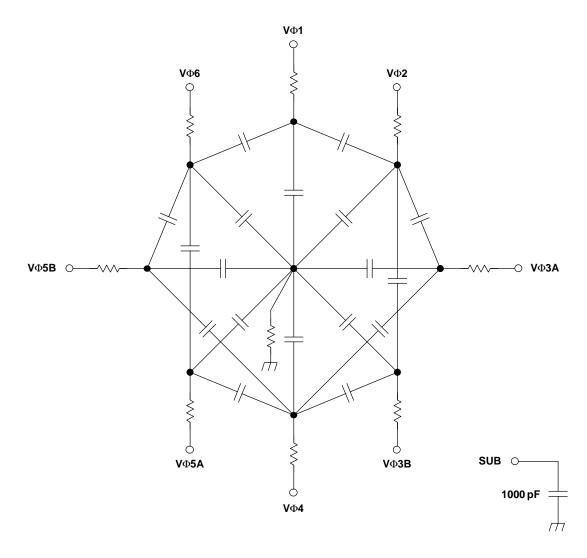


Figure 1. VSP1900 Loading Diagram



DESCRIPTION

The VSP1900 is a CCD vertical clock driver with electric shutter. The VSP1900 is composed of five 3-state and three 2-state vertical transfer channels, which support both 3 field and 2 field CCD operation. The VSP1900 contributes low power consumption and parts number reduction in the system.

OPERATION

Power On/Off Sequence

This is the same as the CCD power up sequence, when power on, VDD powers on first VH, VM power on second, and VL powers on later. When powering off, VL powers off first, VH, VM power of second, and VDD powers off later.

Vertical Transfer Signal

The VSP1900 receives signals from TG (CCD timing generator). The input signal is converted into CCD operation voltage level by the level shifter. The level shifter circuits connect to a 2-state or 3-state driver, which is connected to the CCD input pin. While using a 2-field CCD, one of the 3-state drivers is used as a 2-state driver. The CH#N pin is pulled up internally, so that the VH level does not appear on the output pin.

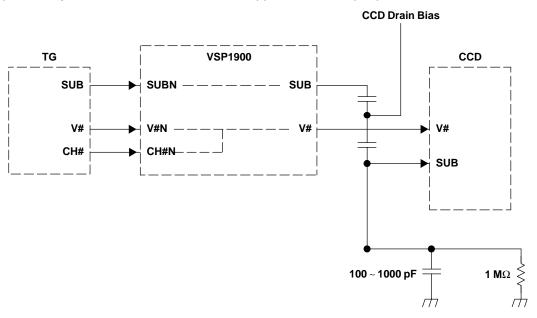


Figure 2. FVSP1900 Circuit Application

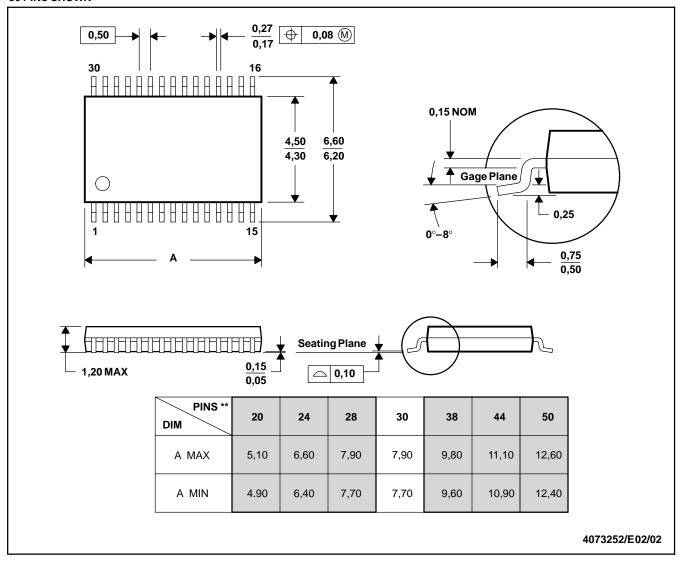


MECHANICAL DATA

DBT (R-PDSO-G**)

30 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE

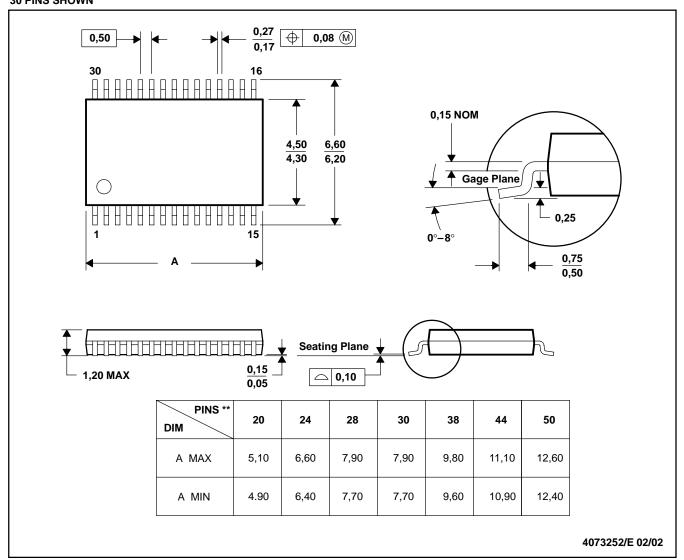


- NOTES: A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion.
 - D. Falls within JEDEC MO-153

DBT (R-PDSO-G**)

30 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion.

D. Falls within JEDEC MO-153

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